



Product Change Notification

104475 - 00

Information in this document is provided in connection with Intel® products. No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Intel's Terms and Conditions of Sale for such products, Intel assumes no liability whatsoever, and Intel disclaims any express or implied warranty, relating to sale and/or use of Intel® products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. Intel® products are not intended for use in medical, life saving, or life sustaining applications. Intel may make changes to specifications and product descriptions at any time, without notice.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geography location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

Copyright © Intel Corporation 2004. Other names and brands may be claimed as the property of others.

AlertVIEW, AnyPoint, AppChoice, EtherExpress, FlashFile, i386, i486, i960, Intel, Celeron, Intel486, Intel740, IntelDX2, IntelDX4, IntelSX2, Itanium, LANDesk, LanRover, Pentium, Xeon, Intel Xeon, NetMerge, NetStructure, OverDrive, Paragon, PDCharm, StrataFlash is a trademark or registered trademarks of Intel corporation or its subsidiaries in the United States and other countries.

Learn how to use Intel Trade Marks and Brands correctly at <http://www.intel.com/intel/legal/tmusage2.htm>.



Product Change Notification

Change Notification #: 104475 - 00
Change Title: Intel(R) Wireless Flash Memory (W18) 32Mb with 8Mb SRAM, PCN 104475-00, FYI, SRAM change from .15 μ m lithography to .13 μ m lithography
Date of Publication: October 12, 2004

Type of Change Notification:
FYI - (For Your Information)

Key Characteristics of the Change:
Process

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Nov 15, 2004
---	--------------

Description of Change to the Customer:

Intel will begin assembling the 32/8 W18 stacked device with .13 μ m SRAM. Prior production material had been assembled using the .15 μ m SRAM. Intel will fully qualify this new SRAM and the new stack will meet Intel's stringent quality and reliability standards. The new .13 μ m SRAM has the same functional specifications as the existing .15 μ m SRAM. As a result, Intel will not modify the part number and pre/post change product could ship interchangeably. The "Products Affected" table below lists the current part numbers for the 32/8 W18 stacked devices.

Customer Impact of Change and Recommended Action:

Intel does not anticipate any impact to customer applications. This SRAM lithography change meets Intel's quality and reliability standards and is backwards compatible with Intel's current stacked chip scale package.

Products Affected / Intel Ordering Codes:

Component Product Table

Affected Product Code	Spec/ROM	Affected MM#
PF38F1020W0YBQ0862990		862990
PF38F1020W0YBQ0S B48	S B48	862991
PF38F1020W0YBQ0S B93	S B93	862992
PF38F1020W0YTQ0862993		862993
PF38F1020W0YTQ0S B48	S B48	862994
PF38F1020W0YTQ0S B93	S B93	862995

Affected Product Code	Spec/ROM	Affected MM#
RD38F1020W0YBQ0859064		859064
RD38F1020W0YBQ0S B48	S B48	858992
RD38F1020W0YBQ0S B93	S B93	858994
RD38F1020W0YTQ0859065		859065
RD38F1020W0YTQ0S B93	S B93	858995

Reference Documents / Attachments:

Document:

Location #:

PCN Revision History:

Date of Revision:

October 12, 2004

Revision Number:

00

Reason:

Originally Published PCN